

ABSTRACT OF THE DISCLOSURE

A technique for accommodating electronic components on a multilayer signal routing device is disclosed. In one particular exemplary embodiment, the technique may be realized 5 as a method for accommodating electronic components on a multilayer signal routing device. Such a method comprises determining a component space that is required to accommodate a plurality of electronic components on a surface of a multilayer signal routing device, and then forming at least one signal 10 routing channel on at least the surface of the multilayer signal routing device, wherein the at least one signal routing channel has a channel space that is equal to or greater than the component space.